

SC030N65Y

55 Amps, 650 Volts N-Channel Sic Power MOSFET

Features

- 55A, 650V, $R_{DS(ON)MAX}=50\text{m}\Omega$ @ $V_{GS}=18\text{V}/25\text{A}$
- High Blocking Voltage with low On-Resistance
- High Speed Switching with Low Capacitance
- Fast Intrinsic Diode with Low Reverse Recovery(Q_{rr})

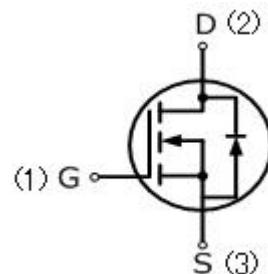
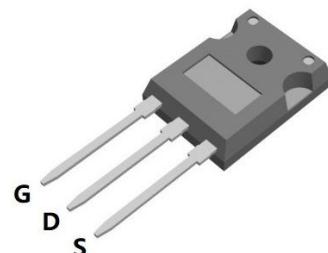
Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency
- Easy to Parallel and Simple to Drive
- Enable Totem-Pole PFC Topologies

Applications

- Solar Inverters
- Server Power Supplies
- Solar PV Inverters
- UPS
- DC/DC Converters

TO-247-3L



Absolute Maximum Ratings ($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Value	UNIT	Test Conditions
Drain-Source Voltage	V_{DSmax}	650	V	$V_{GS}=0\text{V}, I_{DS}=100\mu\text{A}$
Gate-Source Voltage(dynamic)	V_{GSmax}	-8/+22		Absolute maximum values
Gate-Source Voltage (static)	V_{GSop}	-4/+18		Recommended operational values
Continuous Drain Current	I_D	55	A	$V_{GS}=18\text{V}, T_c=25^\circ\text{C}$
		39		$V_{GS}=18\text{V}, T_c=100^\circ\text{C}$
Pulsed Drain Current	$I_{D(pulse)}$	197	A	Pulse width t_p limited by T_{Jmax}
Power Dissipation	P_D	187	W	$T_c=25^\circ\text{C}, T_J=175^\circ\text{C}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-40 to +175	°C	

Thermal Characteristics

Parameter	Symbol	SC030N65Y	Units
Typical Junction-to-Case	R_{thJC}	0.8	°C/W

Electrical Characteristics ($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=100\mu\text{A}$	650	—	—	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=650\text{V}, V_{\text{GS}}=0\text{V}$	—	1	50	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=22\text{V}, V_{\text{DS}}=0\text{V}$	—	10	250	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=10\text{mA}$	1.8	2.6	4.3	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=18\text{V}, I_{\text{D}}=25\text{A}$ $V_{\text{GS}}=18\text{V}, I_{\text{D}}=25\text{A}, T_J=175^\circ\text{C}$	—	30	50	$\text{m}\Omega$
Input Capacitance	C_{iss}	$V_{\text{DS}}=400\text{V}, V_{\text{GS}}=0\text{V},$ $f=1.0\text{MHz}, V_{\text{AC}}=25\text{mV}$	—	2000	—	
Output Capacitance	C_{oss}		—	180	—	pF
Reverse Transfer Capacitance	C_{rss}		—	19	—	pF
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DS}}=400\text{V}, V_{\text{GS}}=-4\text{V}/18\text{V},$ $I_{\text{D}}=25\text{A}, R_g=2.5\Omega, R_L=16\Omega$	—	14	—	ns
Turn-On Rise Time	t_r		—	15	—	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		—	28	—	ns
Turn-Off Fall Time	t_f		—	8	—	ns
Turn-On Switching Energy	E_{ON}	$V_{\text{DS}}=400\text{V}, V_{\text{GS}}=-4\text{V}/18\text{V}$	—	50	—	μJ
Turn-Off Switching Energy	E_{OFF}	$I_{\text{D}}=50\text{A}, R_g=2.5\Omega, L=100\mu\text{H}$	—	65	—	μJ
Internal Gate Resistance	R_g	$f=1\text{MHz}, V_{\text{AC}}=25\text{mV}$	—	2.5	—	Ω
Total Gate Charge	Q_g	$V_{\text{DS}}=400\text{V}, I_{\text{D}}=25\text{A},$ $V_{\text{GS}}=-4\text{V}/18\text{V}$	—	110	—	nC
Gate-Source Charge	Q_{gs}		—	30	—	
Gate-Drain Charge	Q_{gd}		—	32	—	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	$V_{\text{GS}}=-4\text{V}, I_{\text{SD}}=12.5\text{A}$ $V_{\text{GS}}=-4\text{V}, I_{\text{SD}}=12.5\text{A}, T_J=175^\circ\text{C}$	—	4.2	—	V
Continuous Diode Forward Current	I_s	$V_{\text{GS}}=-4\text{V}, T_c=25^\circ\text{C}$	—	—	45	
Reverse Recover Time	t_{rr}	$V_R=400\text{V}, I_{\text{SD}}=25\text{A}$	—	25	—	ns
Reverse Recovery Charge	Q_{rr}		—	100	—	nc
Peak Reverse Recovery Current	I_{rrm}		—	5	—	A

RATING AND CHARACTERISTIC CURVES

Figure.1 Output Characteristics $T_j=25^\circ\text{C}$

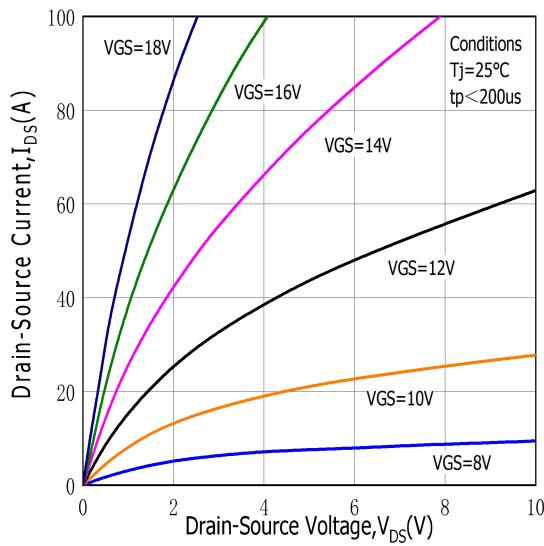


Figure.2 Output Characteristics $T_j=175^\circ\text{C}$

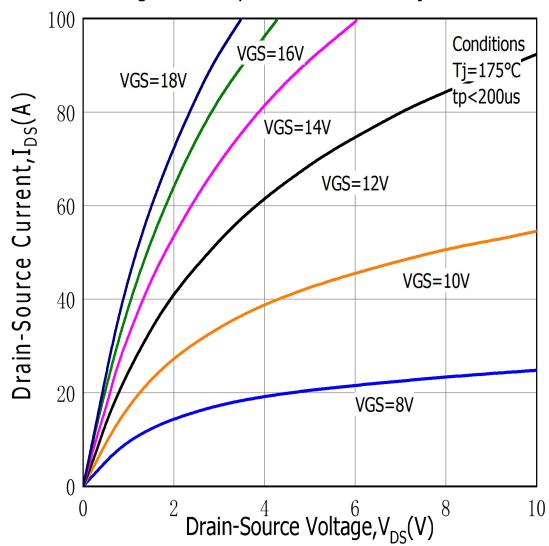


Figure.3 Normalized On-Resistance vs.Temperature

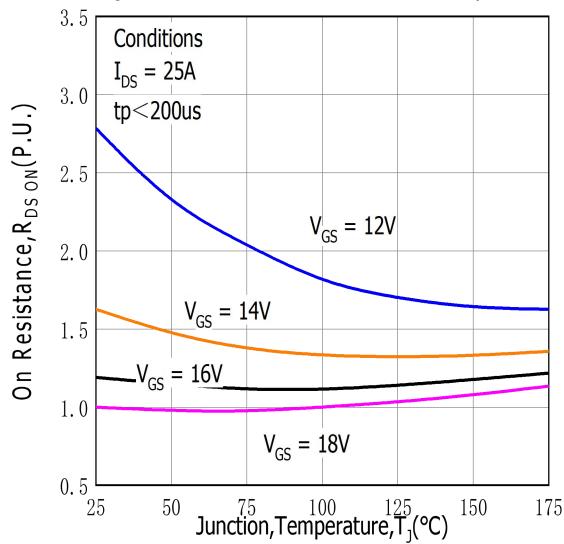


Figure.4 Body Diode Characteristic at 25°C

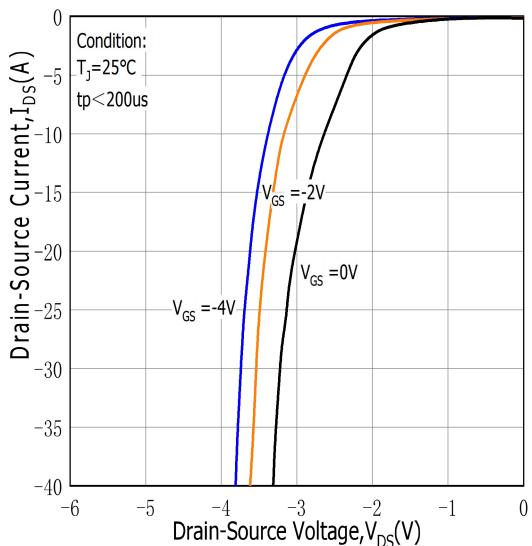


Figure.5 Body Diode Characteristic at 175°C

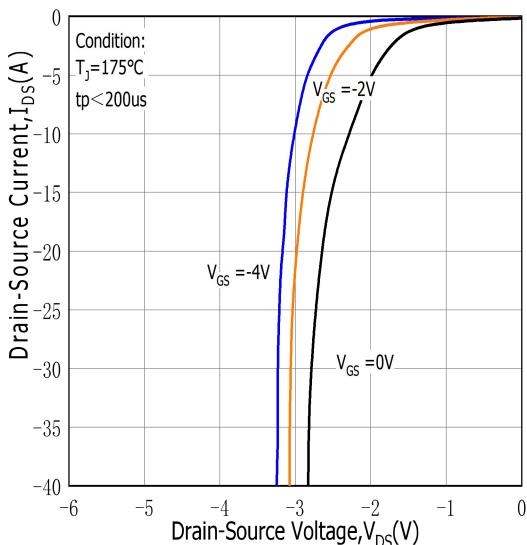


Figure.6 Threshold Voltage vs.Temperature

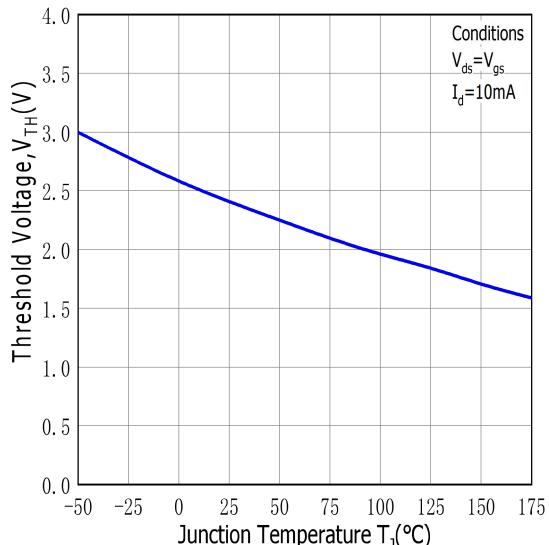


Figure.7 3rd Quadrant Characteristic at 25°C

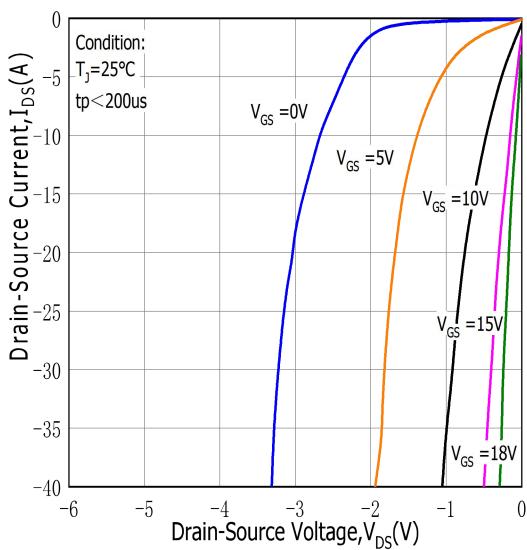


Figure.8 3rd Quadrant Characteristic at 175°C

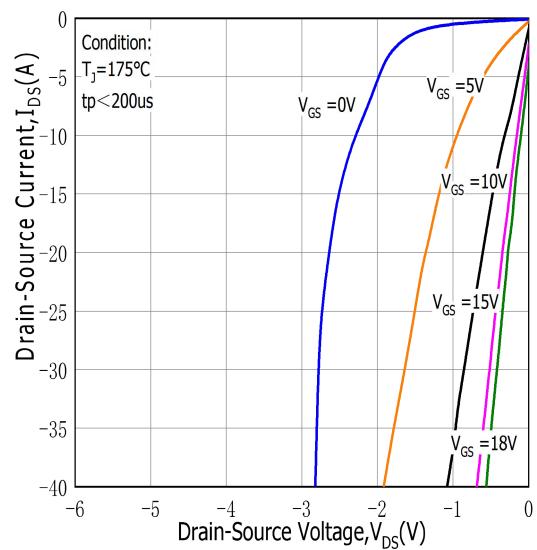


Figure.9 Capacitances vs. Drain-Source Voltage(0-200V)

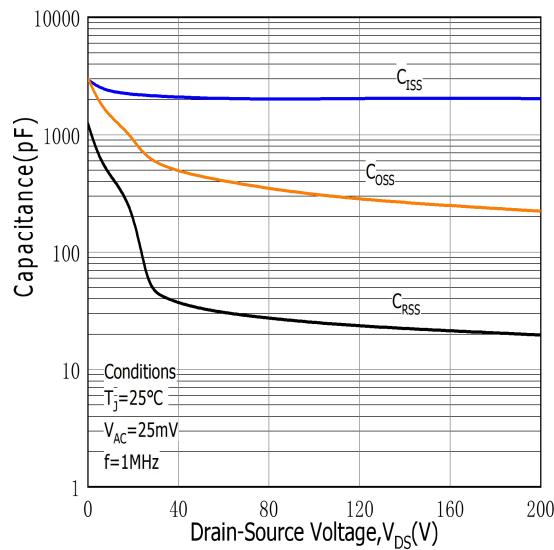
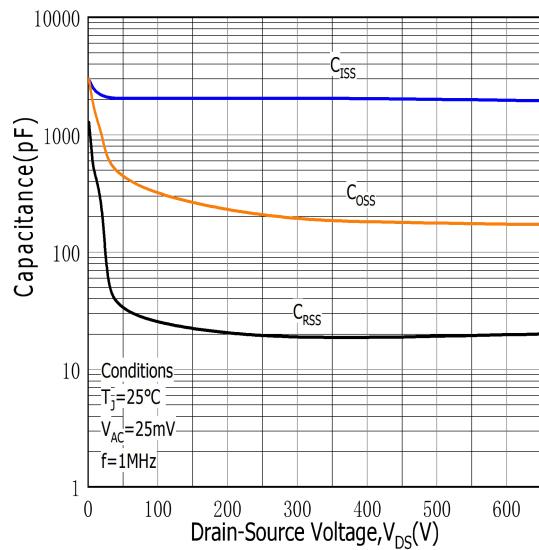
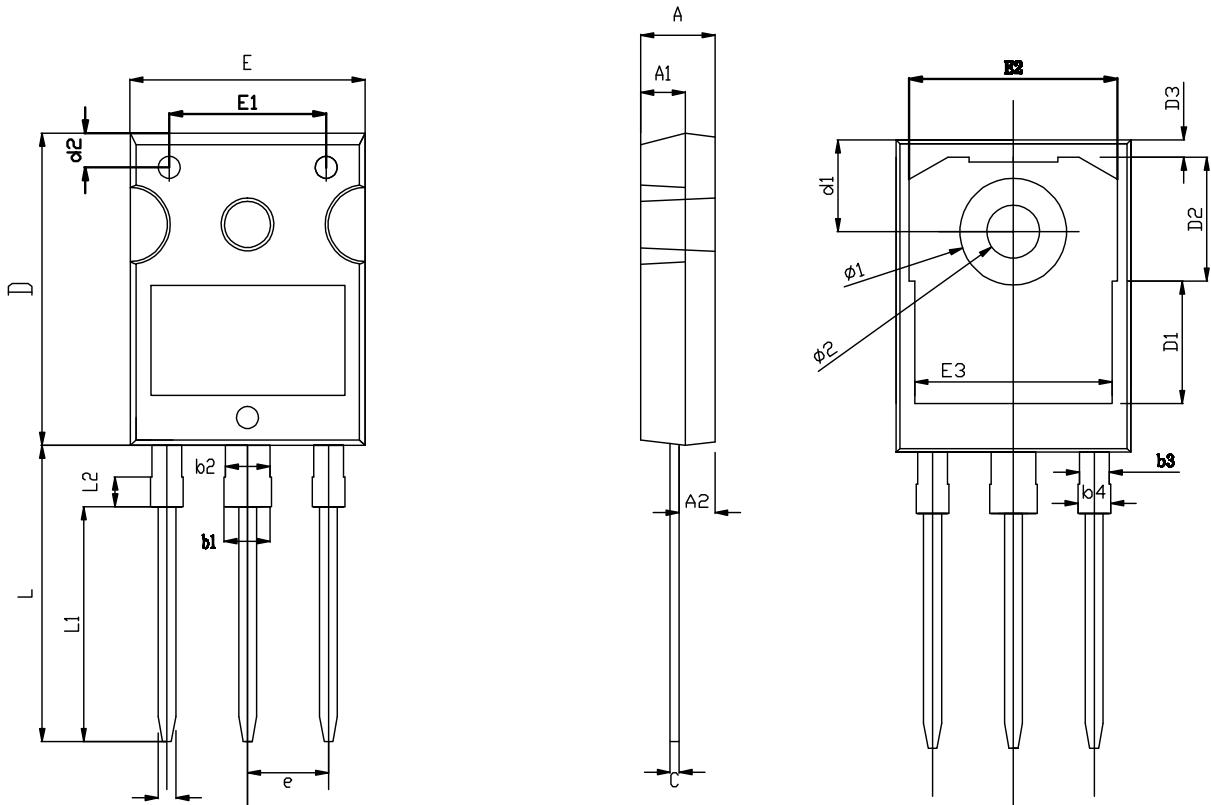


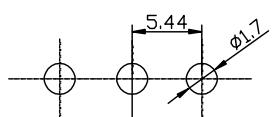
Figure.10 Capacitances vs. Drain-Source Voltage(0-1000V)



TO-247-3L PACKAGE OUTLINE



RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.80	3.00	3.20
A2	2.26	2.41	2.56
b	1.10	1.20	1.30
b1	2.90	-	3.20
b2	2.90	3.00	3.10
b3	1.90	2.00	2.10
b4	2.00	-	2.20
c	0.50	0.60	0.70
D	20.80	21.00	21.20
D1		8.23	
D2		8.32	
D3		1.17	
d1	6.00	6.15	6.30
d2	2.20	2.30	2.40
E	15.60	15.80	16.00
E1		10.50	
E2		14.02	
E3		13.50	
e	5.34	5.44	5.54
L	19.72	19.92	20.12
L1		15.79	
L2		1.98	
$\phi 1$	7.10	7.19	7.30
$\phi 2$	3.50	3.60	3.70